<b>PCN Number:</b> 20190315000.0	<b>PCN Date:</b>	Marc	ch 15, 2019	
Title: Datasheet for AFE4900				
<b>Customer Contact:</b> PCN Manager		De	<b>ept:</b> Quality Services	
Change Type:				
Assembly Site Design	n		Wafer Bump Site	
Assembly Process Data	Sheet		Wafer Bump Material	
	number change		Wafer Bump Process	
Mechanical Specification Test 9			Wafer Fab Site	
Packing/Shipping/Labeling Test	Process		Wafer Fab Materials	
			Wafer Fab Process	
Notific	ation Details			
Description of Change:				
Texas Instruments Incorporated is announcir	ng an information or	nly no	otification.	
The product datasheet(s) is being updated as	s summarized below	·.		
The following change history provides further				
TEXAS				
INSTRUMENTS			AFE4900	
Changes from Original (August 2017) to Revision A	SBA	S857A	-AUGUST 2017-REVISED FEBRUARY 2019 Page	
The reserve to the second of t				
<ul> <li>Changed the values of Programmable INA Gain in Fe</li> </ul>				
<ul> <li>Added "IEC 60601 Test Report Available on Request"</li> </ul>				
<ul> <li>Changed the typical value of INA gain range parameter</li> </ul>				
<ul> <li>Changed the typical value of AC input impedance part</li> </ul>				
<ul> <li>Changed the value of INA gain in the footnote of Elect</li> </ul>	trical Characteristics section	on	7	
Changed Figure 12				
<ul> <li>Changed the value of INA gain in the condition of Typ</li> </ul>	ical Characteristics: PPG	+ ECC	G Mode section 14	
Changed Figure 21				
<ul> <li>Changed values of INA Gain in the captions of Figure</li> </ul>	23 and Figure 24			
<ul> <li>Changed value of INA Gain in the caption of Figure 20</li> </ul>	ā			
<ul> <li>Added a note in Arrangement of FIFO Data in PTT Me</li> </ul>				
Changed Power Modes section				
<ul> <li>Added a sentence below Different Modes of Operation</li> </ul>				
Added Register 30h in Register Map table				
Added Register 30h Description				
<ul> <li>Changed reset (hardware or software reset) to hardware</li> </ul>				
Deleted Reference Circuits for ECG Signal Acquisition	section and added Syste	m des	sign to optimize ECG signal	
acquisition section.				
Deleted ECG Lead-Off Detection section				
Changed Figure 186 and Figure 187		*********		
The datasheet number will be changing.	Chanas Franci		Change Tay	
Device Family	Change From:		Change To:	
AFE4900	SBAS857		SBAS857A	
The document is not available on the TI webs Engineer (CQE) for a copy of the datasheet.	site. Please contact	the T	ΓΙ Customer Quality	
Reason for Change:				
To accurately reflect device characteristics.				
,	6 III 5 II			
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):				
No anticipated impact. This is a specification	cnange announceme	ent c	only. There are no changes	
to the actual device.				
Changes to product identification resulti	ng from this PCN:			
None.				
Product Affected:				

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For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

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